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PATENT ABSTRACTS OF JAPAN

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states:

(71) Applicant: **MEIDENSHA CORP**

(72) Inventor: **YAMADA MASAKI**

(74) Representative:

(54) **PRINTED BOARD GROUP**

(57) Abstract:

PURPOSE: To reduce the space required at the time of mechanically and electrically coupling printed boards to each other.

CONSTITUTION: Conductors 13 are stuck to the outer peripheral surface of a support 11 used for coupling printed boards 10 to each other and, in addition, through holes 15 are provided through the printed boards around hole 14 for inserting screw and the conductors 13 are soldered after both ends of the conductors 13 are put in the through holes 15.

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